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### Understanding [Embedded - FPGAs \(Field Programmable Gate Array\)](#)

Embedded - FPGAs, or Field Programmable Gate Arrays, are advanced integrated circuits that offer unparalleled flexibility and performance for digital systems. Unlike traditional fixed-function logic devices, FPGAs can be programmed and reprogrammed to execute a wide array of logical operations, enabling customized functionality tailored to specific applications. This reprogrammability allows developers to iterate designs quickly and implement complex functions without the need for custom hardware.

### Applications of Embedded - FPGAs

The versatility of Embedded - FPGAs makes them indispensable in numerous fields. In telecommunications.

#### Details

Product Status	Obsolete
Number of LABs/CLBs	26
Number of Logic Elements/Cells	208
Total RAM Bits	-
Number of I/O	68
Number of Gates	2500
Voltage - Supply	4.75V ~ 5.25V
Mounting Type	Surface Mount
Operating Temperature	0°C ~ 70°C (TA)
Package / Case	84-LCC (J-Lead)
Supplier Device Package	84-PLCC (29.31x29.31)
Purchase URL	<a href="https://www.e-xfl.com/product-detail/intel/epf8282alc84-4n">https://www.e-xfl.com/product-detail/intel/epf8282alc84-4n</a>

JTAG BST circuitry	Yes	No	Yes	Yes	No	Yes
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## ...and More Features

- Peripheral register for fast setup and clock-to-output delay
- Fabricated on an advanced SRAM process
- Available in a variety of packages with 84 to 304 pins (see [Table 2](#))
- Software design support and automatic place-and-route provided by the Altera® MAX+PLUS® II development system for Windows-based PCs, as well as Sun SPARCstation, HP 9000 Series 700/800, and IBM RISC System/6000 workstations
- Additional design entry and simulation support provided by EDIF 2.0.0 and 3.0.0 netlist files, library of parameterized modules (LPM), Verilog HDL, VHDL, and other interfaces to popular EDA tools from manufacturers such as Cadence, Exemplar Logic, Mentor Graphics, OrCAD, Synopsys, Synplicity, and Veribest

**Table 2. FLEX 8000 Package Options & I/O Pin Count** *Note (1)*

Device	84-Pin PLCC	100-Pin TQFP	144-Pin TQFP	160-Pin PQFP	160-Pin PGA	192-Pin PGA	208-Pin PQFP	225-Pin BGA	232-Pin PGA	240-Pin PQFP	280-Pin PGA	304-Pin RQFP
EPF8282A	68	78										
EPF8282AV		78										
EPF8452A	68	68		120	120							
EPF8636A	68			118		136	136					
EPF8820A			112	120		152	152	152				
EPF81188A							148		184	184		
EPF81500A										181	208	208

**Note:**

- (1) FLEX 8000 device package types include plastic J-lead chip carrier (PLCC), thin quad flat pack (TQFP), plastic quad flat pack (PQFP), power quad flat pack (RQFP), ball-grid array (BGA), and pin-grid array (PGA) packages.

## General Description

Altera's Flexible Logic Element MatriX (FLEX®) family combines the benefits of both erasable programmable logic devices (EPLDs) and field-programmable gate arrays (FPGAs). The FLEX 8000 device family is ideal for a variety of applications because it combines the fine-grained architecture and high register count characteristics of FPGAs with the high speed and predictable interconnect delays of EPLDs. Logic is implemented in LEs that include compact 4-input look-up tables (LUTs) and programmable registers. High performance is provided by a fast, continuous network of routing resources.

FLEX 8000 devices provide a large number of storage elements for applications such as digital signal processing (DSP), wide-data-path manipulation, and data transformation. These devices are an excellent choice for bus interfaces, TTL integration, coprocessor functions, and high-speed controllers. The high-pin-count packages can integrate multiple 32-bit buses into a single device. [Table 3](#) shows FLEX 8000 performance and LE requirements for typical applications.

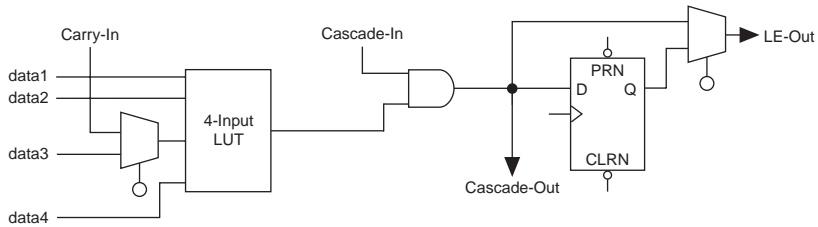
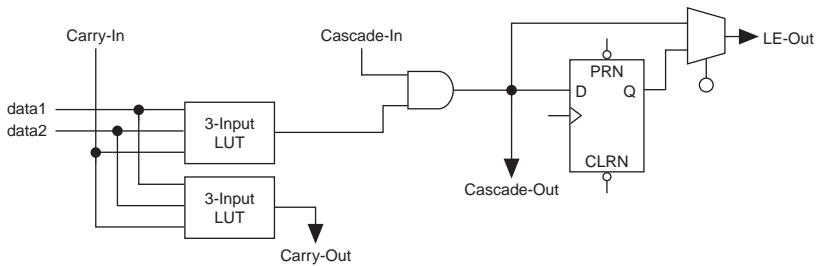
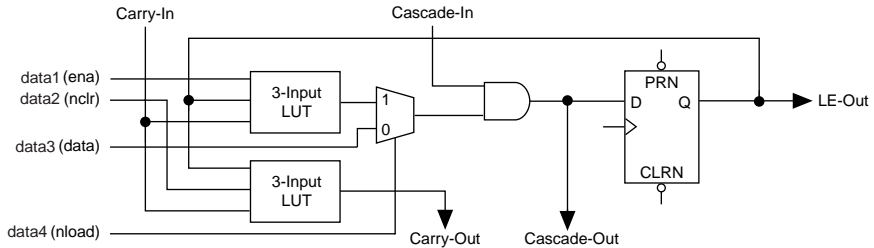
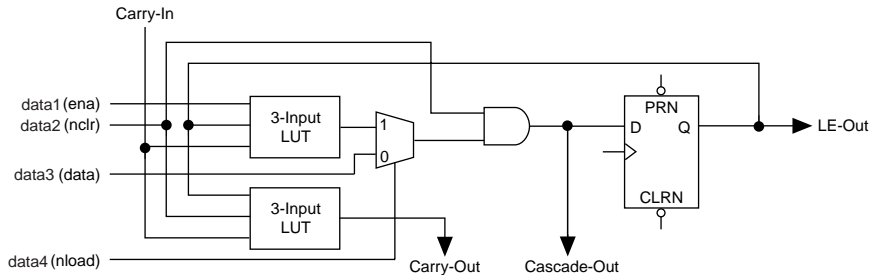
**Table 3. FLEX 8000 Performance**

Application	LEs Used	Speed Grade			Units
		A-2	A-3	A-4	
16-bit loadable counter	16	125	95	83	MHz
16-bit up/down counter	16	125	95	83	MHz
24-bit accumulator	24	87	67	58	MHz
16-bit address decode	4	4.2	4.9	6.3	ns
16-to-1 multiplexer	10	6.6	7.9	9.5	ns

All FLEX 8000 device packages provide four dedicated inputs for synchronous control signals with large fan-outs. Each I/O pin has an associated register on the periphery of the device. As outputs, these registers provide fast clock-to-output times; as inputs, they offer quick setup times.

The logic and interconnections in the FLEX 8000 architecture are configured with CMOS SRAM elements. FLEX 8000 devices are configured at system power-up with data stored in an industry-standard parallel EPROM or an Altera serial configuration devices, or with data provided by a system controller. Altera offers the EPC1, EPC1213, EPC1064, and EPC1441 configuration devices, which configure FLEX 8000 devices via a serial data stream. Configuration data can also be stored in an industry-standard 32 K × 8 bit or larger configuration device, or downloaded from system RAM. After a FLEX 8000 device has been configured, it can be reconfigured in-circuit by resetting the device and loading new data. Because reconfiguration requires less than 100 ms, real-time changes can be made during system operation. For information on how to configure FLEX 8000 devices, go to the following documents:

- [Configuration Devices for APEX & FLEX Devices Data Sheet](#)
- [BitBlaster Serial Download Cable Data Sheet](#)
- [ByteBlasterMV Parallel Port Download Cable Data Sheet](#)
- [Application Note 33 \(Configuring FLEX 8000 Devices\)](#)
- [Application Note 38 \(Configuring Multiple FLEX 8000 Devices\)](#)

**Figure 6. FLEX 8000 LE Operating Modes****Normal Mode****Arithmetic Mode****Up/Down Counter Mode****Clearable Counter Mode**

### Normal Mode

The normal mode is suitable for general logic applications and wide decoding functions that can take advantage of a cascade chain. In normal mode, four data inputs from the LAB local interconnect and the carry-in signal are the inputs to a 4-input LUT. Using a configurable SRAM bit, the MAX+PLUS II Compiler automatically selects the carry-in or the DATA3 signal as an input. The LUT output can be combined with the cascade-in signal to form a cascade chain through the cascade-out signal. The LE-Out signal—the data output of the LE—is either the combinatorial output of the LUT and cascade chain, or the data output (Q) of the programmable register.

### Arithmetic Mode

The arithmetic mode offers two 3-input LUTs that are ideal for implementing adders, accumulators, and comparators. One LUT provides a 3-bit function; the other generates a carry bit. As shown in Figure 6, the first LUT uses the carry-in signal and two data inputs from the LAB local interconnect to generate a combinatorial or registered output. For example, in an adder, this output is the sum of three bits: a, b, and the carry-in. The second LUT uses the same three signals to generate a carry-out signal, thereby creating a carry chain. The arithmetic mode also supports a cascade chain.

### Up/Down Counter Mode

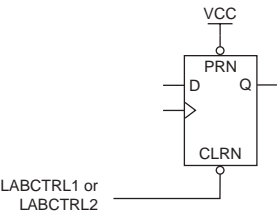
The up/down counter mode offers counter enable, synchronous up/down control, and data loading options. These control signals are generated by the data inputs from the LAB local interconnect, the carry-in signal, and output feedback from the programmable register. Two 3-input LUTs are used: one generates the counter data, and the other generates the fast carry bit. A 2-to-1 multiplexer provides synchronous loading. Data can also be loaded asynchronously with the clear and preset register control signals, without using the LUT resources.

### Clearable Counter Mode

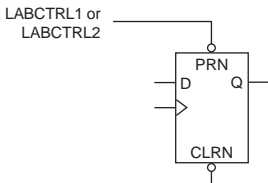
The clearable counter mode is similar to the up/down counter mode, but supports a synchronous clear instead of the up/down control; the clear function is substituted for the cascade-in signal in the up/down counter mode. Two 3-input LUTs are used: one generates the counter data, and the other generates the fast carry bit. Synchronous loading is provided by a 2-to-1 multiplexer, and the output of this multiplexer is ANDed with a synchronous clear.

Figure 7. FLEX 8000 LE Asynchronous Clear & Preset Modes

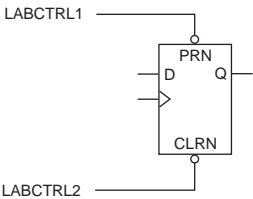
Asynchronous Clear



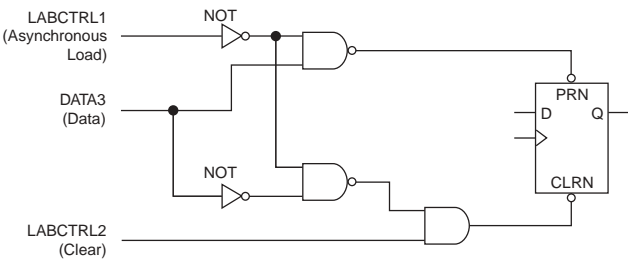
Asynchronous Preset



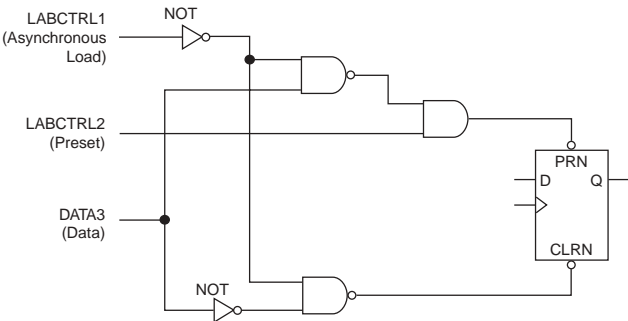
Asynchronous Clear & Preset



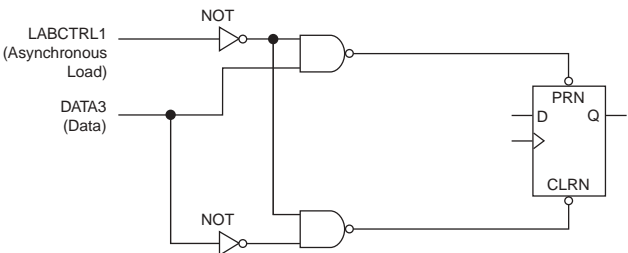
Asynchronous Load with Clear



Asynchronous Load with Preset



Asynchronous Load without Clear or Preset



### **Asynchronous Clear**

A register is cleared by one of the two LABCTRL signals. When the CLRn port receives a low signal, the register is set to zero.

### **Asynchronous Preset**

An asynchronous preset is implemented as either an asynchronous load or an asynchronous clear. If DATA3 is tied to VCC, asserting LABCTRL1 asynchronously loads a 1 into the register. Alternatively, the MAX+PLUS II software can provide preset control by using the clear and inverting the input and output of the register. Inversion control is available for the inputs to both LEs and IOEs. Therefore, if a register is preset by only one of the two LABCTRL signals, the DATA3 input is not needed and can be used for one of the LE operating modes.

### **Asynchronous Clear & Preset**

When implementing asynchronous clear and preset, LABCTRL1 controls the preset and LABCTRL2 controls the clear. The DATA3 input is tied to VCC; therefore, asserting LABCTRL1 asynchronously loads a 1 into the register, effectively presetting the register. Asserting LABCTRL2 clears the register.

### **Asynchronous Load with Clear**

When implementing an asynchronous load with the clear, LABCTRL1 implements the asynchronous load of DATA3 by controlling the register preset and clear. LABCTRL2 implements the clear by controlling the register clear.

### **Asynchronous Load with Preset**

When implementing an asynchronous load in conjunction with a preset, the MAX+PLUS II software provides preset control by using the clear and inverting the input and output of the register. Asserting LABCTRL2 clears the register, while asserting LABCTRL1 loads the register. The MAX+PLUS II software inverts the signal that drives the DATA3 signal to account for the inversion of the register's output.

### **Asynchronous Load without Clear or Preset**

When implementing an asynchronous load without the clear or preset, LABCTRL1 implements the asynchronous load of DATA3 by controlling the register preset and clear.

Each LE in an LAB can drive up to two separate column interconnect channels. Therefore, all 16 available column channels can be driven by the LAB. The column channels run vertically across the entire device, and share access to LABs in the same column but in different rows. The MAX+PLUS II Compiler chooses which LEs must be connected to a column channel. A row interconnect channel can be fed by the output of the LE or by two column channels. These three signals feed a multiplexer that connects to a specific row channel. Each LE is connected to one 3-to-1 multiplexer. In an LAB, the multiplexers provide all 16 column channels with access to 8 row channels.

Each column of LABs has a dedicated column interconnect that routes signals out of the LABs into the column. The column interconnect can then drive I/O pins or feed into the row interconnect to route the signals to other LABs in the device. A signal from the column interconnect, which can be either the output of an LE or an input from an I/O pin, must transfer to the row interconnect before it can enter an LAB. [Table 4](#) summarizes the FastTrack Interconnect resources available in each FLEX 8000 device.

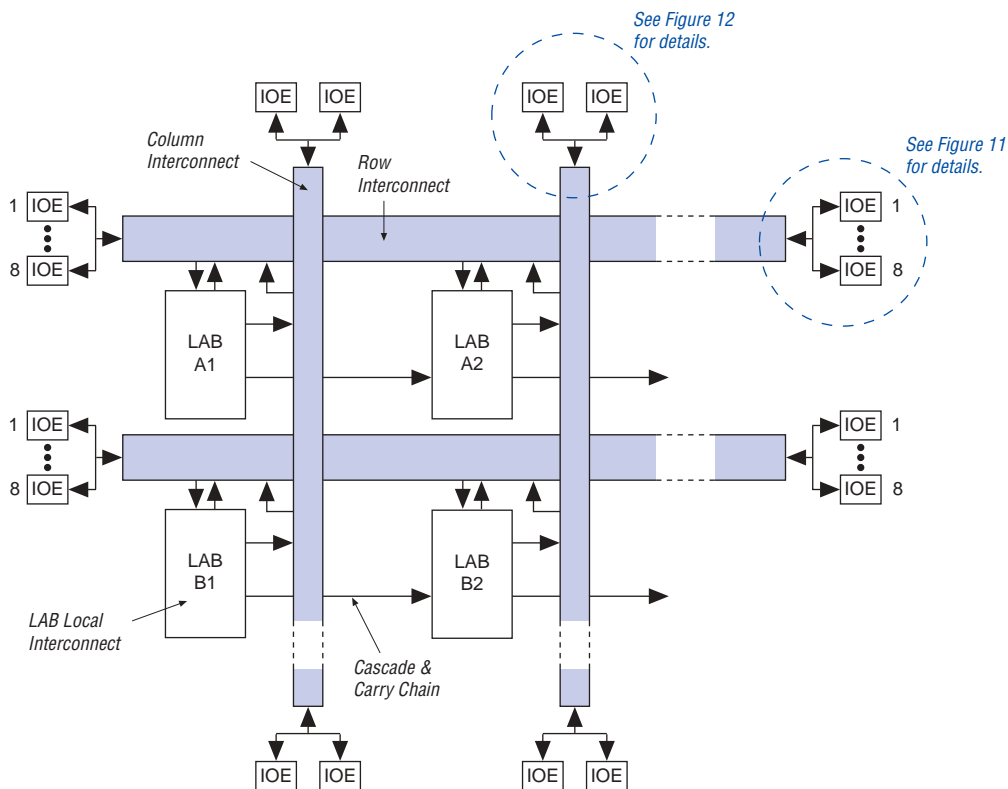
<b>Table 4. FLEX 8000 FastTrack Interconnect Resources</b>				
<b>Device</b>	<b>Rows</b>	<b>Channels per Row</b>	<b>Columns</b>	<b>Channels per Column</b>
EPF8282A EPF8282AV	2	168	13	16
EPF8452A	2	168	21	16
EPF8636A	3	168	21	16
EPF8820A	4	168	21	16
EPF81188A	6	168	21	16
EPF81500A	6	216	27	16

[Figure 9](#) shows the interconnection of four adjacent LABs, with row, column, and local interconnects, as well as the associated cascade and carry chains.



**Figure 9. FLEX 8000 Device Interconnect Resources**

Each LAB is named according to its physical row (A, B, C, etc.) and column (1, 2, 3, etc.) position within the device.



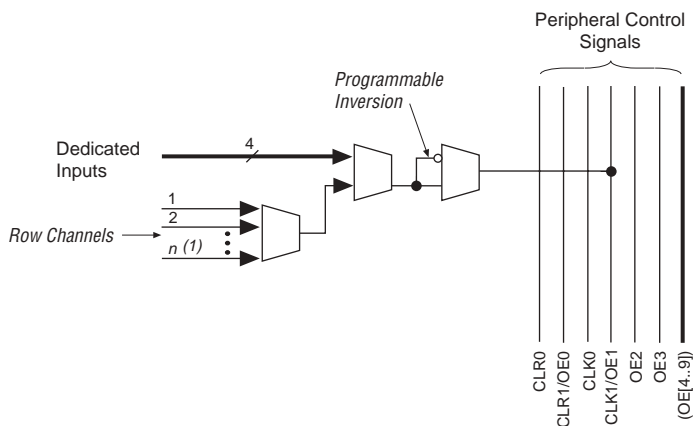
## I/O Element

An IOE contains a bidirectional I/O buffer and a register that can be used either as an input register for external data that requires a fast setup time, or as an output register for data that requires fast clock-to-output performance. IOEs can be used as input, output, or bidirectional pins. The MAX+PLUS II Compiler uses the programmable inversion option to automatically invert signals from the row and column interconnect where appropriate. Figure 10 shows the IOE block diagram.

The signals for the peripheral bus can be generated by any of the four dedicated inputs or signals on the row interconnect channels, as shown in Figure 13. The number of row channels in a row that can drive the peripheral bus correlates to the number of columns in the FLEX 8000 device. EPF8282A and EPF8282AV devices use 13 channels; EPF8452A, EPF8636A, EPF8820A, and EPF81188A devices use 21 channels; and EPF81500A devices use 27 channels. The first LE in each LAB is the source of the row channel signal. The six peripheral control signals (12 in EPF81500A devices) can be accessed by each IOE.

**Figure 13. FLEX 8000 Peripheral Bus**

*Numbers in parentheses are for EPF81500A devices.*



**Note:**

- (1)  $n = 13$  for EPF8282A and EPF8282AV devices.
- $n = 21$  for EPF8452A, EPF8636A, EPF8820A, and EPF81188A devices.
- $n = 27$  for EPF81500A devices.

## MultiVolt I/O Interface

The FLEX 8000 device architecture supports the MultiVolt I/O interface feature, which allows EPF81500A, EPF81188A, EPF8820A, and EPF8636A devices to interface with systems with differing supply voltages. These devices in all packages—except for EPF8636A devices in 84-pin PLCC packages—can be set for 3.3-V or 5.0-V I/O pin operation. These devices have one set of  $V_{CC}$  pins for internal operation and input buffers ( $V_{CCINT}$ ), and another set for I/O output drivers ( $V_{CCIO}$ ).

The  $V_{CCINT}$  pins must always be connected to a 5.0-V power supply. With a 5.0-V  $V_{CCINT}$  level, input voltages are at TTL levels and are therefore compatible with 3.3-V and 5.0-V inputs.

The  $V_{CCIO}$  pins can be connected to either a 3.3-V or 5.0-V power supply, depending on the output requirements. When the  $V_{CCIO}$  pins are connected to a 5.0-V power supply, the output levels are compatible with 5.0-V systems. When the  $V_{CCIO}$  pins are connected to a 3.3-V power supply, the output high is at 3.3 V and is therefore compatible with 3.3-V or 5.0-V systems. Devices operating with  $V_{CCIO}$  levels lower than 4.75 V incur a nominally greater timing delay of  $t_{OD2}$  instead of  $t_{OD1}$ . See [Table 8 on page 26](#).

## IEEE Std. 1149.1 (JTAG) Boundary-Scan Support

The EPF8282A, EPF8282AV, EPF8636A, EPF8820A, and EPF81500A devices provide JTAG BST circuitry. FLEX 8000 devices with JTAG circuitry support the JTAG instructions shown in [Table 6](#).

**Table 6. EPF8282A, EPF8282AV, EPF8636A, EPF8820A & EPF81500A JTAG Instructions**

JTAG Instruction	Description
SAMPLE/PRELOAD	Allows a snapshot of the signals at the device pins to be captured and examined during normal device operation, and permits an initial data pattern to be output at the device pins.
EXTEST	Allows the external circuitry and board-level interconnections to be tested by forcing a test pattern at the output pins and capturing test results at the input pins.
BYPASS	Places the 1-bit bypass register between the $TDI$ and $TDO$ pins, which allows the BST data to pass synchronously through the selected device to adjacent devices during normal device operation.

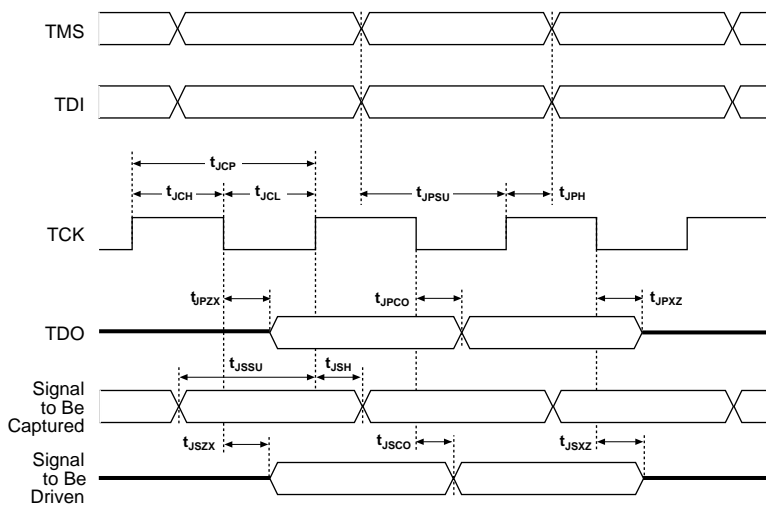
The instruction register length for FLEX 8000 devices is three bits. [Table 7](#) shows the boundary-scan register length for FLEX 8000 devices.

**Table 7. FLEX 8000 Boundary-Scan Register Length**

Device	Boundary-Scan Register Length
EPF8282A, EPF8282AV	273
EPF8636A	417
EPF8820A	465
EPF81500A	645

FLEX 8000 devices that support JTAG include weak pull-ups on the JTAG pins. [Figure 14](#) shows the timing requirements for the JTAG signals.

**Figure 14. EPF8282A, EPF8282AV, EPF8636A, EPF8820A & EPF81500A JTAG Waveforms**



[Table 8](#) shows the timing parameters and values for EPF8282A, EPF8282AV, EPF8636A, EPF8820A, and EPF81500A devices.

**Table 10. FLEX 8000 5.0-V Device Recommended Operating Conditions**

Symbol	Parameter	Conditions	Min	Max	Unit
$V_{CCINT}$	Supply voltage for internal logic and input buffers	(3), (4)	4.75 (4.50)	5.25 (5.50)	V
$V_{CCIO}$	Supply voltage for output buffers, 5.0-V operation	(3), (4)	4.75 (4.50)	5.25 (5.50)	V
	Supply voltage for output buffers, 3.3-V operation	(3), (4)	3.00 (3.00)	3.60 (3.60)	V
$V_I$	Input voltage		-0.5	$V_{CCINT} + 0.5$	V
$V_O$	Output voltage		0	$V_{CCIO}$	V
$T_A$	Operating temperature	For commercial use	0	70	° C
		For industrial use	-40	85	° C
$t_R$	Input rise time			40	ns
$t_F$	Input fall time			40	ns

**Table 11. FLEX 8000 5.0-V Device DC Operating Conditions** Notes (5), (6)

Symbol	Parameter	Conditions	Min	Typ	Max	Unit
$V_{IH}$	High-level input voltage		2.0		$V_{CCINT} + 0.5$	V
$V_{IL}$	Low-level input voltage		-0.5		0.8	V
$V_{OH}$	5.0-V high-level TTL output voltage	$I_{OH} = -4$ mA DC (7) $V_{CCIO} = 4.75$ V	2.4			V
	3.3-V high-level TTL output voltage	$I_{OH} = -4$ mA DC (7) $V_{CCIO} = 3.00$ V	2.4			V
	3.3-V high-level CMOS output voltage	$I_{OH} = -0.1$ mA DC (7) $V_{CCIO} = 3.00$ V	$V_{CCIO} - 0.2$			V
$V_{OL}$	5.0-V low-level TTL output voltage	$I_{OL} = 12$ mA DC (7) $V_{CCIO} = 4.75$ V			0.45	V
	3.3-V low-level TTL output voltage	$I_{OL} = 12$ mA DC (7) $V_{CCIO} = 3.00$ V			0.45	V
	3.3-V low-level CMOS output voltage	$I_{OL} = 0.1$ mA DC (7) $V_{CCIO} = 3.00$ V			0.2	V
$I_I$	Input leakage current	$V_I = V_{CC}$ or ground	-10		10	μA
$I_{OZ}$	Tri-state output off-state current	$V_O = V_{CC}$ or ground	-40		40	μA
$I_{CC0}$	$V_{CC}$ supply current (standby)	$V_I =$ ground, no load		0.5	10	mA

**Table 19. FLEX 8000 Interconnect Timing Parameters** *Note (1)*

Symbol	Parameter
$t_{LABCASC}$	Cascade delay between LEs in different LABs
$t_{LABCARRY}$	Carry delay between LEs in different LABs
$t_{LOCAL}$	LAB local interconnect delay
$t_{ROW}$	Row interconnect routing delay (4)
$t_{COL}$	Column interconnect routing delay
$t_{DIN\_C}$	Dedicated input to LE control delay
$t_{DIN\_D}$	Dedicated input to LE data delay (4)
$t_{DIN\_IO}$	Dedicated input to IOE control delay

**Table 20. FLEX 8000 External Reference Timing Characteristics** *Note (5)*

Symbol	Parameter
$t_{DRR}$	Register-to-register delay via 4 LEs, 3 row interconnects, and 4 local interconnects (6)
$t_{ODH}$	Output data hold time after clock (7)

**Notes to tables:**

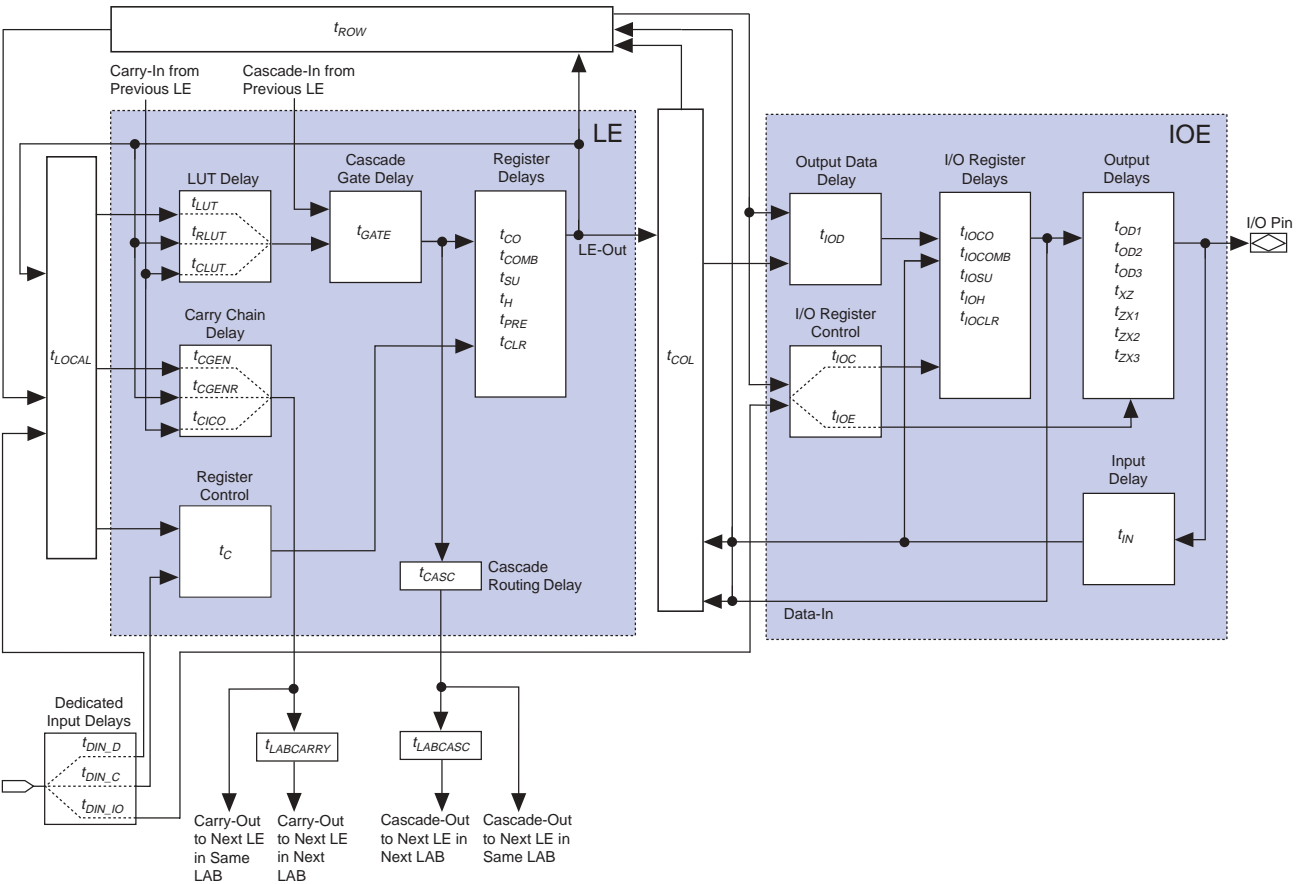
- (1) Internal timing parameters cannot be measured explicitly. They are worst-case delays based on testable and external parameters specified by Altera. Internal timing parameters should be used for estimating device performance. Post-compilation timing simulation or timing analysis is required to determine actual worst-case performance.
- (2) These values are specified in [Table 10 on page 28](#) or [Table 14 on page 29](#).
- (3) For the  $t_{OD3}$  and  $t_{ZX3}$  parameters,  $V_{CCIO} = 3.3\text{ V}$  or  $5.0\text{ V}$ .
- (4) The  $t_{ROW}$  and  $t_{DIN\_D}$  delays are worst-case values for typical applications. Post-compilation timing simulation or timing analysis is required to determine actual worst-case performance.
- (5) External reference timing characteristics are factory-tested, worst-case values specified by Altera. A representative subset of signal paths is tested to approximate typical device applications.
- (6) For more information on test conditions, see [Application Note 76 \(Understanding FLEX 8000 Timing\)](#).
- (7) This parameter is a guideline that is sample-tested only and is based on extensive device characterization. This parameter applies to global and non-global clocking, and for LE and I/O element registers.

The FLEX 8000 timing model shows the delays for various paths and functions in the circuit. See [Figure 19](#). This model contains three distinct parts: the LE; the IOE; and the interconnect, including the row and column FastTrack Interconnect, LAB local interconnect, and carry and cascade interconnect paths. Each parameter shown in [Figure 19](#) is expressed as a worst-case value in [Tables 22 through 49](#). Hand-calculations that use the FLEX 8000 timing model and these timing parameters can be used to estimate FLEX 8000 device performance. Timing simulation or timing analysis after compilation is required to determine the final worst-case performance. [Table 21](#) summarizes the interconnect paths shown in [Figure 19](#).



For more information on timing parameters, go to [Application Note 76 \(Understanding FLEX 8000 Timing\)](#).

Figure 19. FLEX 8000 Timing Model



**Table 23. EPF8282A Interconnect Timing Parameters**

Symbol	Speed Grade						Unit
	A-2		A-3		A-4		
	Min	Max	Min	Max	Min	Max	
$t_{LABCASC}$		0.3		0.3		0.4	ns
$t_{LABCARRY}$		0.3		0.3		0.4	ns
$t_{LOCAL}$		0.5		0.6		0.8	ns
$t_{ROW}$		4.2		4.2		4.2	ns
$t_{COL}$		2.5		2.5		2.5	ns
$t_{DIN\_C}$		5.0		5.0		5.5	ns
$t_{DIN\_D}$		7.2		7.2		7.2	ns
$t_{DIN\_IO}$		5.0		5.0		5.5	ns



**Table 40. EPF8820A LE Timing Parameters**

Symbol	Speed Grade						Unit
	A-2		A-3		A-4		
	Min	Max	Min	Max	Min	Max	
$t_{LUT}$		2.0		2.5		3.2	ns
$t_{CLUT}$		0.0		0.0		0.0	ns
$t_{RLUT}$		0.9		1.1		1.5	ns
$t_{GATE}$		0.0		0.0		0.0	ns
$t_{CASC}$		0.6		0.7		0.9	ns
$t_{CICO}$		0.4		0.5		0.6	ns
$t_{CGEN}$		0.4		0.5		0.7	ns
$t_{CGENR}$		0.9		1.1		1.5	ns
$t_C$		1.6		2.0		2.5	ns
$t_{CH}$	4.0		4.0		4.0		ns
$t_{CL}$	4.0		4.0		4.0		ns
$t_{CO}$		0.4		0.5		0.6	ns
$t_{COMB}$		0.4		0.5		0.6	ns
$t_{SU}$	0.8		1.1		1.2		ns
$t_H$	0.9		1.1		1.5		ns
$t_{PRE}$		0.6		0.7		0.8	ns
$t_{CLR}$		0.6		0.7		0.8	ns

**Table 41. EPF8820A External Timing Parameters**

Symbol	Speed Grade						Unit
	A-2		A-3		A-4		
	Min	Max	Min	Max	Min	Max	
t <sub>DRR</sub>		16.0		20.0		25.0	ns
t <sub>ODH</sub>	1.0		1.0		1.0		ns

**Table 48. EPF81500A LE Timing Parameters**

Symbol	Speed Grade						Unit
	A-2		A-3		A-4		
	Min	Max	Min	Max	Min	Max	
$t_{LUT}$		2.0		2.5		3.2	ns
$t_{CLUT}$		0.0		0.0		0.0	ns
$t_{RLUT}$		0.9		1.1		1.5	ns
$t_{GATE}$		0.0		0.0		0.0	ns
$t_{CASC}$		0.6		0.7		0.9	ns
$t_{CICO}$		0.4		0.5		0.6	ns
$t_{CGEN}$		0.4		0.5		0.7	ns
$t_{CGENR}$		0.9		1.1		1.5	ns
$t_C$		1.6		2.0		2.5	ns
$t_{CH}$	4.0		4.0		4.0		ns
$t_{CL}$	4.0		4.0		4.0		ns
$t_{CO}$		0.4		0.5		0.6	ns
$t_{COMB}$		0.4		0.5		0.6	ns
$t_{SU}$	0.8		1.1		1.2		ns
$t_H$	0.9		1.1		1.5		ns
$t_{PRE}$		0.6		0.7		0.8	ns
$t_{CLR}$		0.6		0.7		0.8	ns

**Table 49. EPF81500A External Timing Parameters**

Symbol	Speed Grade						Unit
	A-2		A-3		A-4		
	Min	Max	Min	Max	Min	Max	
t <sub>DDR</sub>		16.1		20.1		25.1	ns
t <sub>ODH</sub>	1.0		1.0		1.0		ns

## Operating Modes

The FLEX 8000 architecture uses SRAM elements that require configuration data to be loaded whenever the device powers up and begins operation. The process of physically loading the SRAM programming data into the device is called *configuration*. During initialization, which occurs immediately after configuration, the device resets registers, enables I/O pins, and begins to operate as a logic device. The I/O pins are tri-stated during power-up, and before and during configuration. The configuration and initialization processes together are called *command mode*; normal device operation is called *user mode*.

SRAM elements allow FLEX 8000 devices to be reconfigured in-circuit with new programming data that is loaded into the device. Real-time reconfiguration is performed by forcing the device into command mode with a device pin, loading different programming data, reinitializing the device, and resuming user-mode operation. The entire reconfiguration process requires less than 100 ms and can be used to dynamically reconfigure an entire system. In-field upgrades can be performed by distributing new configuration files.

## Configuration Schemes

The configuration data for a FLEX 8000 device can be loaded with one of six configuration schemes, chosen on the basis of the target application. Both active and passive schemes are available. In the active configuration schemes, the FLEX 8000 device functions as the controller, directing the loading operation, controlling external configuration devices, and completing the loading process. The clock source for all active configuration schemes is an oscillator on the FLEX 8000 device that operates between 2 MHz and 6 MHz. In the passive configuration schemes, an external controller guides the FLEX 8000 device. [Table 51](#) shows the data source for each of the six configuration schemes.

<b>Table 51. Data Source for Configuration</b>		
<b>Configuration Scheme</b>	<b>Acronym</b>	<b>Data Source</b>
Active serial	AS	Altera configuration device
Active parallel up	APU	Parallel configuration device
Active parallel down	APD	Parallel configuration device
Passive serial	PS	Serial data path
Passive parallel synchronous	PPS	Intelligent host
Passive parallel asynchronous	PPA	Intelligent host

**Table 53. FLEX 8000 160-, 192- & 208-Pin Package Pin-Outs (Part 1 of 2)**

Pin Name	160-Pin PQFP EPF8452A	160-Pin PQFP EPF8636A	192-Pin PGA EPF8636A EPF8820A	208-Pin PQFP EPF8636A (1)	208-Pin PQFP EPF8820A (1)	208-Pin PQFP EPF8188A (1)
nSP (2)	120	1	R15	207	207	5
MSEL0 (2)	117	3	T15	4	4	21
MSEL1 (2)	84	38	T3	49	49	33
nSTATUS (2)	37	83	B3	108	108	124
nCONFIG (2)	40	81	C3	103	103	107
DCLK (2)	1	120	C15	158	158	154
CONF_DONE (2)	4	118	B15	153	153	138
nWS	30	89	C5	114	114	118
nRS	71	50	B5	66	116	121
RDCLK	73	48	C11	64	137	137
nCS	29	91	B13	116	145	142
CS	27	93	A16	118	148	144
RDYnBUSY	125	155	A8	201	127	128
CLKUSR	76	44	A10	59	134	134
ADD17	78	43	R5	57	43	46
ADD16	91	33	U3	43	42	45
ADD15	92	31	T5	41	41	44
ADD14	94	29	U4	39	40	39
ADD13	95	27	R6	37	39	37
ADD12	96	24	T6	31	35	36
ADD11	97	23	R7	30	33	31
ADD10	98	22	T7	29	31	30
ADD9	99	21	T8	28	29	29
ADD8	101	20	U9	24	25	26
ADD7	102	19	U10	23	23	25
ADD6	103	18	U11	22	21	24
ADD5	104	17	U12	21	19	18
ADD4	105	13	R12	14	14	17
ADD3	106	11	U14	12	13	16
ADD2	109	9	U15	10	11	10
ADD1	110	7	R13	8	10	9
ADD0	123	157	U16	203	9	8
DATA7	144	137	H17	178	178	177
DATA6	150	132	G17	172	176	175
DATA5	152	129	F17	169	174	172

**Table 53. FLEX 8000 160-, 192- & 208-Pin Package Pin-Outs (Part 2 of 2)**

Pin Name	160-Pin PQFP EPF8452A	160-Pin PQFP EPF8636A	192-Pin PGA EPF8636A EPF8820A	208-Pin PQFP EPF8636A (1)	208-Pin PQFP EPF8820A (1)	208-Pin PQFP EPF81188A (1)
DATA4	154	127	E17	165	172	170
DATA3	157	124	G15	162	171	168
DATA2	159	122	F15	160	167	166
DATA1	11	115	E16	149	165	163
DATA0	12	113	C16	147	162	161
SDOUT (3)	128	152	C7 (11)	198	124	119
TDI (4)	—	55	R11	72	20	—
TDO (4)	—	95	B9	120	129	—
TCK (4), (6)	—	57	U8	74	30	—
TMS (4)	—	59	U7	76	32	—
TRST (7)	—	40	R3	54	54	—
Dedicated Inputs (10)	5, 36, 85, 116	6, 35, 87, 116	A5, U5, U13, A13	7, 45, 112, 150	17, 36, 121, 140	13, 41, 116, 146
VCCINT (5.0 V)	21, 41, 53, 67, 80, 81, 100, 121, 133, 147, 160	4, 5, 26, 85, 106	C8, C9, C10, R8, R9, R10, R14	5, 6, 33, 110, 137	5, 6, 27, 48, 119, 141	4, 20, 35, 48, 50, 102, 114, 131, 147
VCCIO (5.0 V or 3.3 V)	—	25, 41, 60, 70, 80, 107, 121, 140, 149, 160	D3, D4, D9, D14, D15, G4, G14, L4, L14, P4, P9, P14	32, 55, 78, 91, 102, 138, 159, 182, 193, 206	26, 55, 69, 87, 102, 131, 159, 173, 191, 206	3, 19, 34, 49, 69, 87, 106, 123, 140, 156, 174, 192
GND	13, 14, 28, 46, 60, 75, 93, 107, 108, 126, 140, 155	15, 16, 36, 37, 45, 51, 75, 84, 86, 96, 97, 117, 126, 131, 154	C4, D7, D8, D10, D11, H4, H14, K4, K14, P7, P8, P10, P11	19, 20, 46, 47, 60, 67, 96, 109, 111, 124, 125, 151, 164, 171, 200	15, 16, 37, 38, 60, 78, 96, 109, 110, 120, 130, 142, 152, 164, 182, 200	11, 12, 27, 28, 42, 43, 60, 78, 96, 105, 115, 122, 132, 139, 148, 155, 159, 165, 183, 201
No Connect (N.C.)	2, 3, 38, 39, 70, 82, 83, 118, 119, 148	2, 39, 82, 119	C6, C12, C13, C14, E3, E15, F3, J3, J4, J14, J15, N3, N15, P3, P15, R4 (12)	1, 2, 3, 16, 17, 18, 25, 26, 27, 34, 35, 36, 50, 51, 52, 53, 104, 105, 106, 107, 121, 122, 123, 130, 131, 132, 139, 140, 141, 154, 155, 156, 157, 208	1, 2, 3, 50, 51, 52, 53, 104, 105, 106, 107, 154, 155, 156, 157, 208	1, 2, 51, 52, 53, 54, 103, 104, 157, 158, 207, 208
Total User I/O Pins (9)	116	114	132, 148 (13)	132	148	144